

eINFOCHIPS

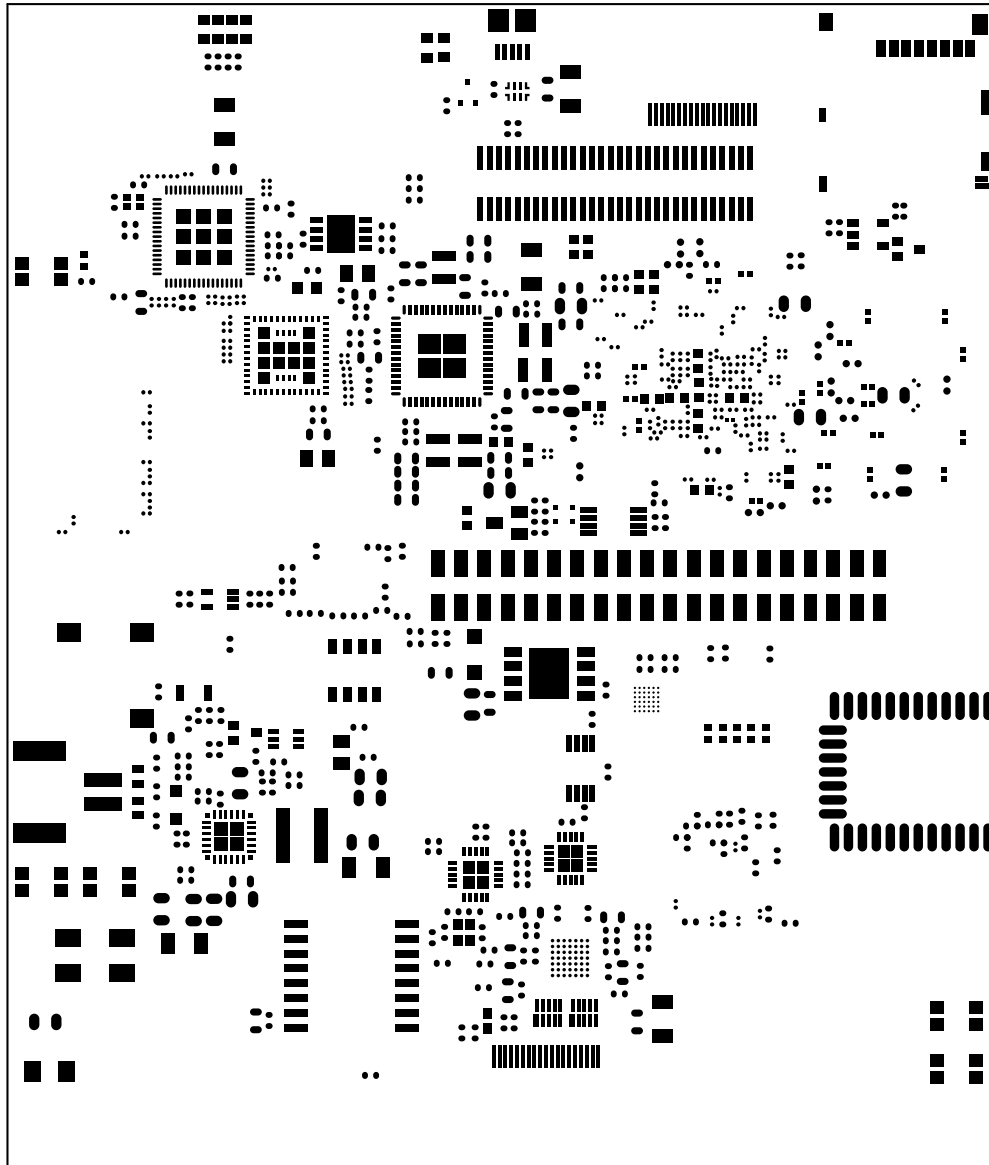
DATE: 08/02/2019

DESIGNED AT: eINFOCHIPS

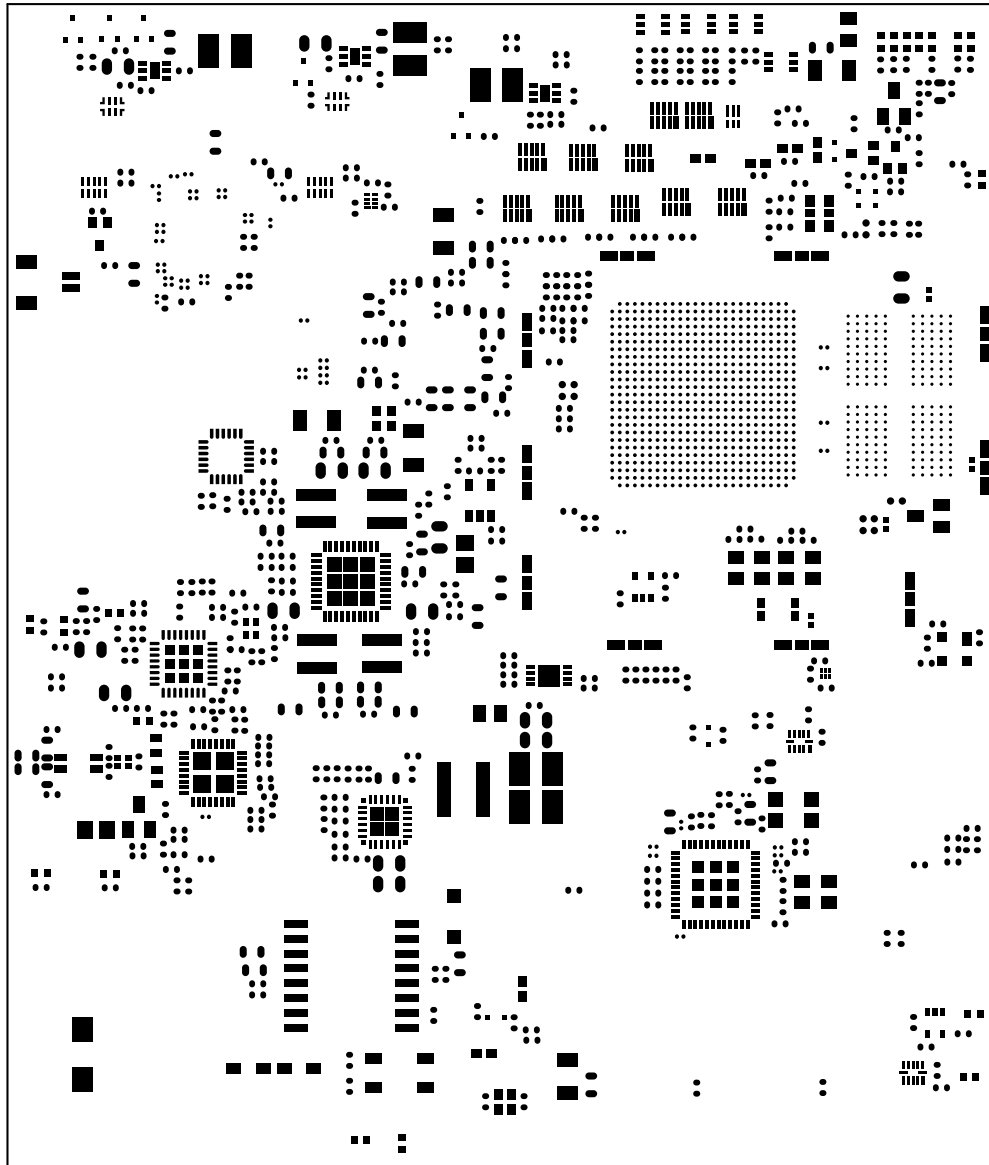
REV: 2.0

PART NO/CARD REF: ARROW_IMX8M_HMI_PLATFORM_BOARD

FILM LAYER : ASSEMBLY PRIMARY SIDE



eINFOCHIPS
DATE: 08/02/2019
DESIGNED AT: eINFOCHIPS
PART NO/CARD REF: ARROW_IMX8M_HMI_PLATFORM BOARD
FILM LAYER : SOLDERPASTE PRIMARY SIDE



eINFOCHIPS

DATE: 08/02/2019

DESIGNED AT: eINFOCHIPS

REV: 2.0

PART NO/CARD REF: ARROW_IMX8M_HMI_PLATFORM BOARD

FILM LAYER : SOLDERPASTE SECONDARY SIDE

DATE: 08/02/2019

REV : 2.0

FILM LAYER : ASSEMBLY SECONDARY SIDE